APPLICA	BLE STAN	DARD								
	OPERATING TEMPERATUR	RE RANGE	-35 °C TO +105°C (NOTE1)			IPERATURE RANGE		-10 °C TO +60°C (NOTE3)		
RATING	OPERATING HUMIDITY RANGE		20% TO 80% (NO	ΓE2)	STORAGE HUMIDITY R	ANGE	40%	(NOTE3))	
	VOLTAGE		50 V AC/DC		APPLICABLE	CONNECTOR	DF65-5S-1.7C			
	CURRENT		AWG 24 : 4.0							
			SPECI	IFICA	TIONS					
	ГЕМ		TEST METHOD			REQUIREMENTS				AT
	RUCTION	T							X	
GENERAL EXAMINATION						ACCORDING TO DRAWING.				X
MARKING		CONFIRMED VISUALLY.							Х	X
	IC CHARA	1			140				Тх	
CONTACT RESISTANCE MILLIVOLT LEVEL METHOD		20mV MAX, 1mA (DC or 1000Hz).			10 ms	10 mΩ MAX.				-
INSULATION RESISTANCE		100 V DC.			100 MΩ	100 ΜΩ ΜΙΝ.				-
VOLTAGE PROOF		500 V AC FOR 1 min.			NO FLA	NO FLASHOVER OR BREAKDOWN.				-
MECHAI	VICAL CHA									
MECHANICAL OPERATION		30 TIMES INSERTION AND EXTRACTION.				①CONTACT RESISTANCE: 20 mΩ MAX.				-
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE				②NO DAMAGE, CRACK OR LOOSENESS OF PARTS. ①NO ELECTRICAL DISCONTINUITY OF 1 μ s.				+-
SHOCK		0.75 mm, AT 10 CYCLES FOR 3 DIRECTION.				②NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				
		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3								T -
	NIMENITAL	DIRECTIO	ACTERISTICS							
DAMP HEAT	INIVICINIAL		O AT 40 ± 2°C , 90 TO 95 %, 9	16 h	(1)CON	ITACT RESIS	TANCE:	20 m Q MAX	. X	Τ_
(STEADY STATE)		(AFTER LEAVING THE ROOM TEMPERATURE FOR 1~2h.)			I	②INSULATION RESISTANCE: 100 MΩ MIN. ③NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				
RAPID CHANGE OF TEMPERATURE			TEMPERATURE -55°C → +85°C TIME 30min→ 30min			ITACT RESIS [.] JLATION RESI			· X	-
		UNDER 5		1	AMAGE, CRACK			s.		
		1,	NSFERRING TIME OF THE TAI		min)	, ,				
RESISTANCE TO		(AFTER LEAVING THE ROOM TEMPERATURE FOR 1~2h.) 1) REFLOW SOLDERING				NO DEFORMATION OF CASE OF				+_
	SOLDERING HEAT		«REFLOW TIME»			EXCESSIVE LOOSENESS OF THE				
COLDEDADILITY		NUMBER OF REFLOW CYCLES : 2 CYCLES MAX. DURATION ABOVE 220 °C, 60 sec. MAX.				TERMINALS.				
		PEAK TEMPERATURE: 250°C 10 sec. MAX.								
		«PRE-HEAT TIME»								
		PRE-HEAT TEMPERATURE (MIN) :150 °C PRE-HEAT TEMPERATURE (MAX) :180 °C								
		PRE-HEAT TIME (MIN) : 90 sec.								
		PRE-HEAT TIME (MAX): 120 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE: 350±10°C, SOLDERING TIME: 3sec.								
		NO STRENGTH ON CONTACT.				NUCODM COAT	INC OF CO	N DED CHALL	X	-
SOLDERABILITY		SOLDERING TEMPERATURE : 245°C DURATION OF IMMERSION :SOLDERING, FOR 5 sec.			ec. COVER	NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				-
NOTE 1: INCI NOTE2:NO C		PERATURE	RISING BY CURRENT.							
		NDITION C	OF LONG TERM STORAGE F	OR UNUS	ED PRODUCT	S BEFOR PC	ON BOA	ARD, AFTER	PCB BC	DARD
			ND HUMIDITTY RANGE IS APP			GE DURING TR				
COUN	IT D	ESCRIPTI	ON OF REVISIONS		DESIGNED		CHE	CKED	DA	ATE
<u>∕0∖</u> REMARKS						APPROVED		MIYAMOTO	_	
T LEWN WATER						CHECKED		MIYAMOTO	_	
						DESIGNED		TT. OHSAKO		
Unless otherwise specified, ref			refer to JIS C 5402.			DRAWN		TT. OHSAKO		
Note QT:Qualification Test AT:Assurance Test X:Applicable Te					DRAWIN	-		ELC4-347307-01		
HS.	SI	SPECIFICATION SHEET			PART NO.	DF65-5P-1. 7V(21)				
	HIR	HIROSE ELECTRIC CO., LTD.			CODE NO.	CL666	CL666-6001-7-21			